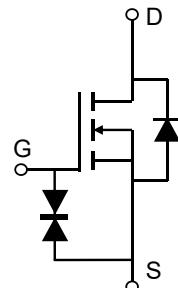


Description

Features

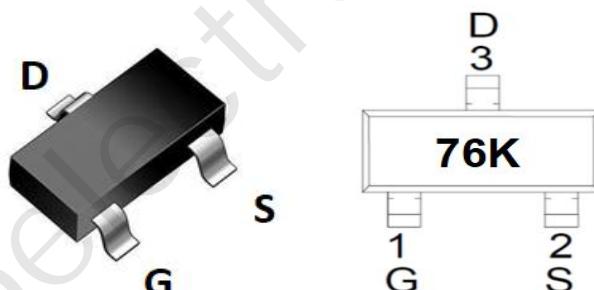
- 60V, 0.18A
- $R_{DS(ON)}$ Typ = 4.9Ω @ V_{GS} = 10V
- $R_{DS(ON)}$ Typ = 5.5Ω @ V_{GS} = 4.5V
- Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead Free
- ESD Protected: 2KV



Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMLTL2N7006K	76K	SOT-23	TAPING	7"	3000	120000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter	Value	Units	
V_{DS}	Drain-to-Source Voltage	60	V	
V_{GS}	Gate-to-Source Voltage	± 20	V	
I_D	Continuous Drain Current	0.18	A	
	$T_A = 100^\circ\text{C}$	0.108	A	
I_{DM}	Pulsed Drain Current ⁽¹⁾	0.72	A	
P_D	Power Dissipation	$T_A = 25^\circ\text{C}$	0.33	W
R_{QJA}	Thermal Resistance, Junction to Ambient ⁽²⁾	380	°C/W	
T_J, T_{STG}	Junction & Storage Temperature Range	-55 to 150	°C	

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	μA
I_{GSS}	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	± 10	μA
On Characteristics						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.5	2	V
$R_{\text{DS(ON)}}$	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10\text{V}, I_D = 0.1\text{A}$	-	4.9	5.9	Ω
		$V_{GS} = 4.5\text{V}, I_D = 0.1\text{A}$	-	5.5	6.6	Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance		-	14	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$	-	2	-	pF
C_{rss}	Reverse Transfer Capacitance		-	0.8	-	pF
Q_g	Total Gate Charge		-	1	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 30\text{V}, I_D = 0.1\text{A}$	-	0.2	-	nC
Q_{gd}	Gate Drain("Miller") Charge		-	0.4	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On DelayTime		-	2.9	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10\text{V}, V_{DD} = 30\text{V}$	-	2.8	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D = 0.1\text{A}, R_{\text{GEN}} = 6\Omega$	-	7	-	ns
t_f	Turn-Off Fall Time		-	6.5	-	ns
Drain-Source Diode Characteristics and Max Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	0.18	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	0.72	A
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = 0.1\text{A}$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	11	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 0.1\text{A}, di/dt = 100\text{A/us}$	-	3	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$.

Test Circuit

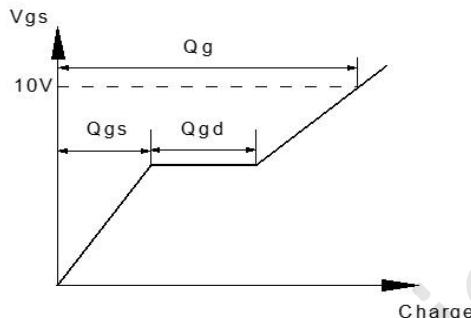
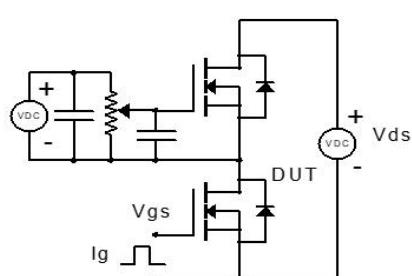


Figure 1: Gate Charge Test Circuit & Waveform

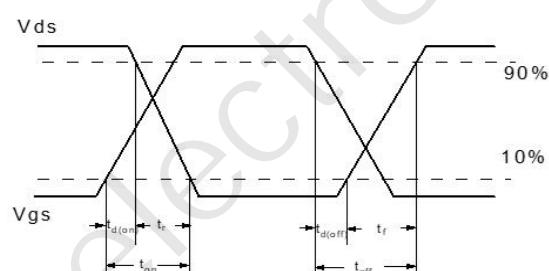
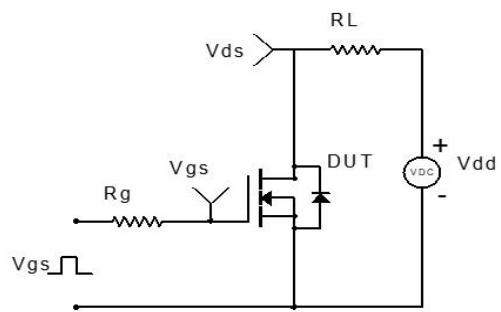


Figure 2: Resistive Switching Test Circuit & Waveform

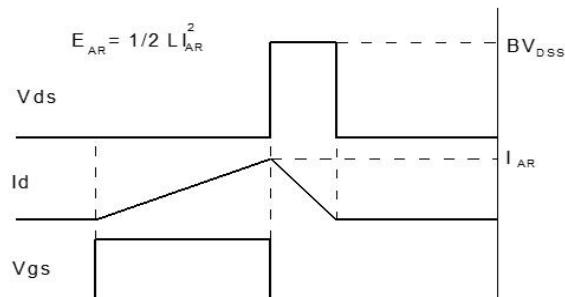
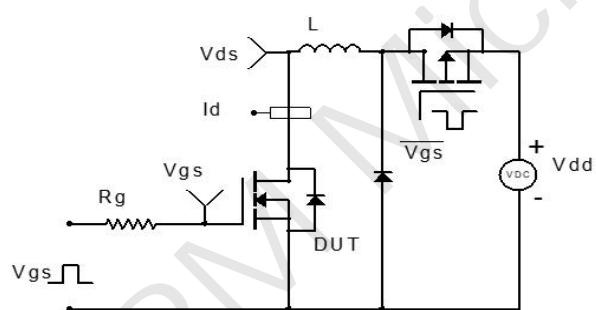


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform

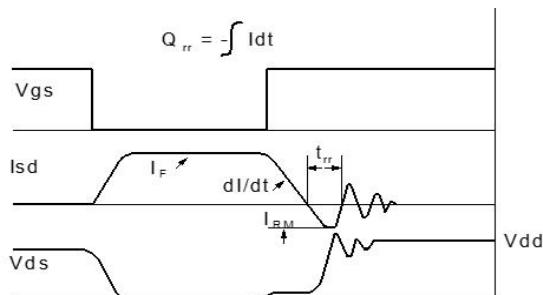
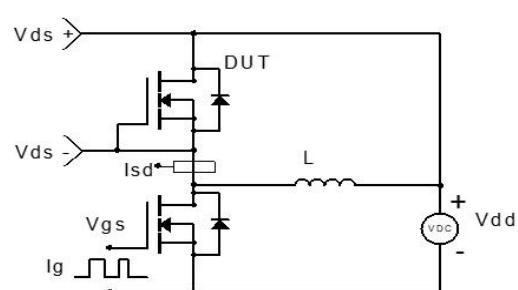
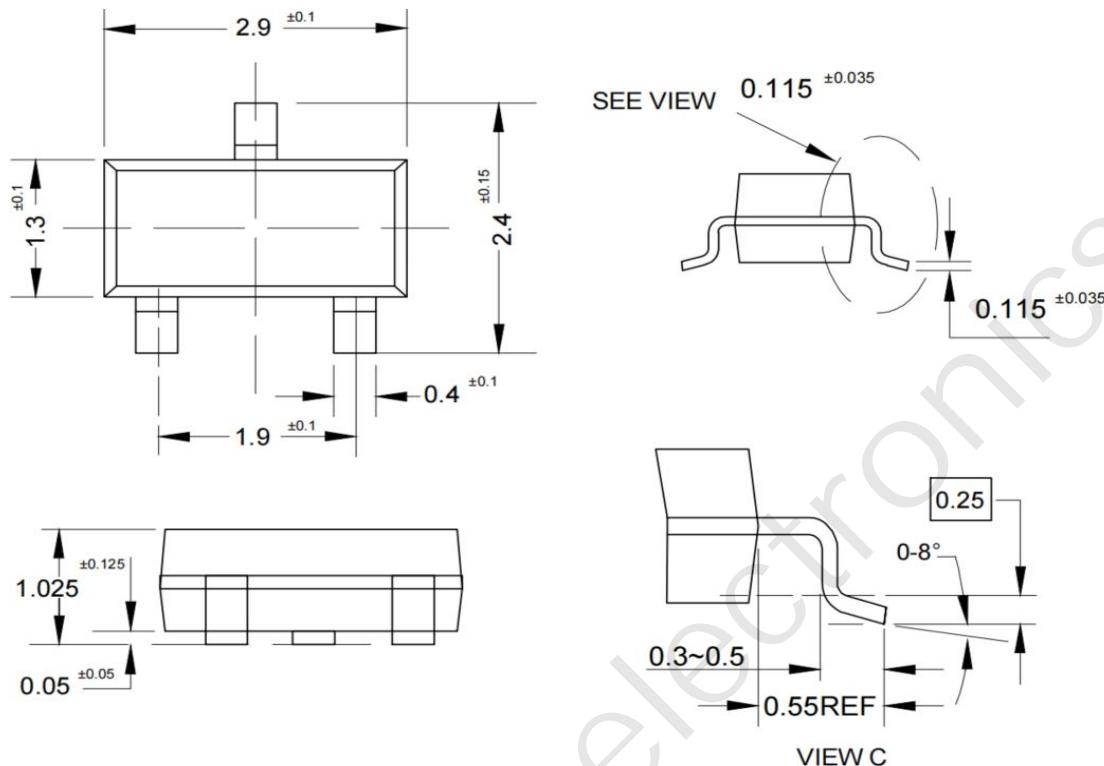


Figure 4: Diode Recovery Test Circuit & Waveform

Package Mechanical Data(SOT-23)



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